OptoTEC[™] OT Series OT12-66-F0-1211-TB-RT-W2.25 MFG Part Number: 430011-508

OptoTEC[™] OT Series Thermoelectric Cooler

The OT12-66-F0-1211-TB-RT-W2.25 is a miniature thermoelectric cooler. The OT12-66-F0-1211-TB-RT-W2.25 is primarily used in applications to stabilize the temperature of sensitive optical components in the telecom and photonics industries. It has a maximum Qc of 4.9 Watts when $\Delta T=0$ and a maximum ΔT of 68 °C at Qc = 0.

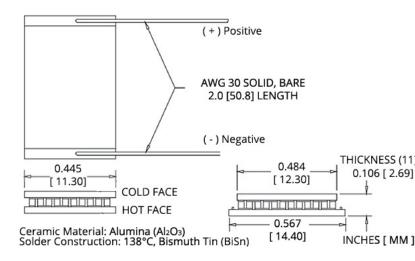
Features

- Miniature geometric sizes
- Precise temperature control
- Reliable solid-state operation
- No sound or vibration
- DC operation
- RoHS-compliant

Applications

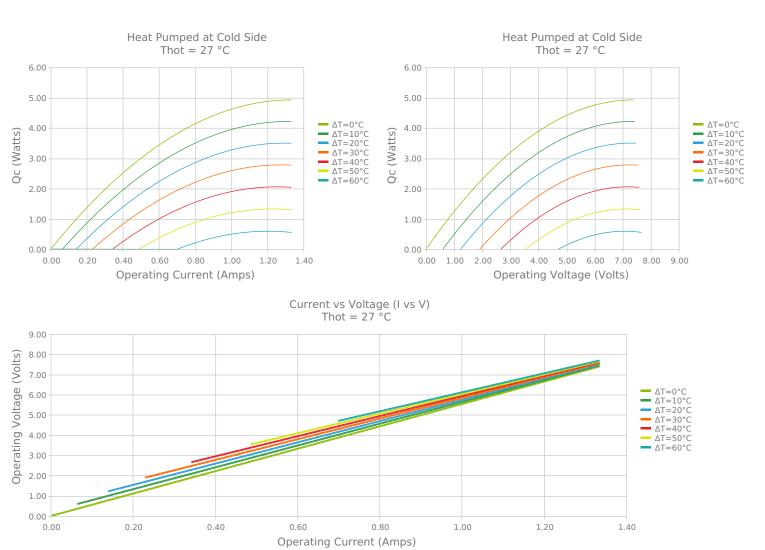
- Thermoelectric Cooling for CMOS Sensors
- Cooling Solutions for Autonomous Systems
- Heads-Up Displays, Imaging Sensors

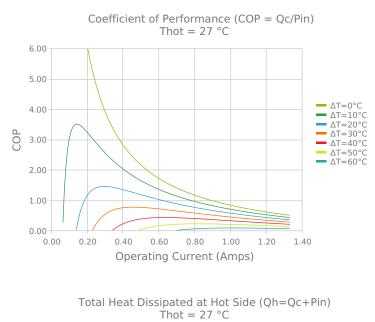


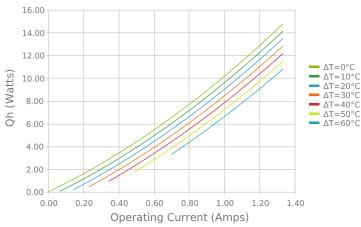


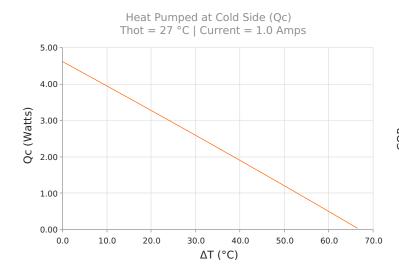
Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

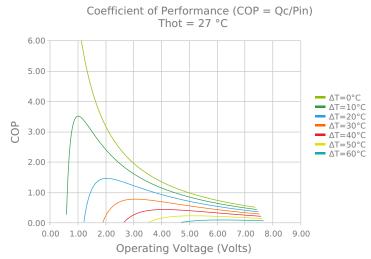
ELECTRICAL AND THERMAL PERFORMANCE







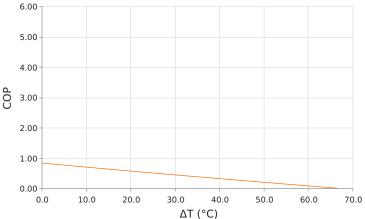




Total Heat Dissipated at Hot Side (Qh=Qc+Pin) Thot = 27 $^{\circ}C$



Coefficient of Performance (COP = Qc/Pin) Thot = 27 °C | Current = 1.0 Amps



SPECIFICATIONS*

Hot Side Temperature	27.0 °C	35.0 °C	50.0 °C
$Qcmax (\Delta T = 0)$	4.9 Watts	5.1 Watts	5.3 Watts
$\Delta Tmax (Qc = 0)$	68.0°C	70.9°C	76.0°C
lmax (I @ ΔTmax)	1.2 Amps	1.2 Amps	1.2 Amps
Vmax (V @ ΔTmax)	7.0 Volts	7.3 Volts	7.8 Volts
Module Resistance	5.54 Ohms	5.77 Ohms	6.20 Ohms
Max Operating Temperature	80 °C		
Weight	2.0 gram(s)		

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
ТВ	$2.692 \pm 0.013 \text{ mm}$ $0.106 \pm 0.001 \text{ in}$	0.013 mm / 0.013 mm 0.0005 in / 0.0005 in	Lapped	Lapped	50.8 mm 2.00 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
RT	RTV	White	-60 to 204°C	Non-corrosive, silicone adhesive

NOTES

- 1. Max operating temperature: 80°C
- 2. Do not exceed Imax or Vmax when operating module
- 3. Reference assembly guidelines for recommended installation
- 4. Solder tinning also available on metallized ceramics

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